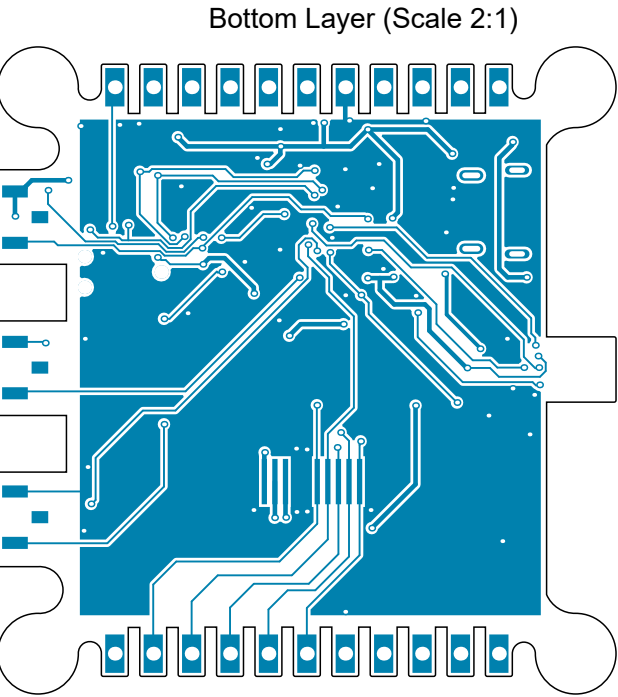


1. Overall PCB Dimensions: 40.9mm x 42.8mm
2. Route to shape on board outline layer .GM8.
3. PCB material shall be FR-4 with min Tg of 140C
4. Copper density shall be 1oz/sq in on all layers
5. Gold ENIG finish on pads
6. LPI solder mask color : RED
7. Legend color - WHITE
8. Minimum drill size : 10mil
9. Minimum trace spacing : 5mil
10. Minimum trace width : 5mil
11. See file with .extrep extension for gerber layer assignments
12. NC Drill file will have a .txt extension
13. 2-Layer stackup with nominal 62.5mil finished thickness +/- 10%
14. Alternate stackup/materials may be used with prior written permission
15. PCB shall be fully electrically tested



	Part Number	LPC55S69_MINI	Rev	A
	Part Description	LPC55S69_MINI		
			Date	2020-04-18
Document Type			Page	1 of 1
PCB Fab Notes				